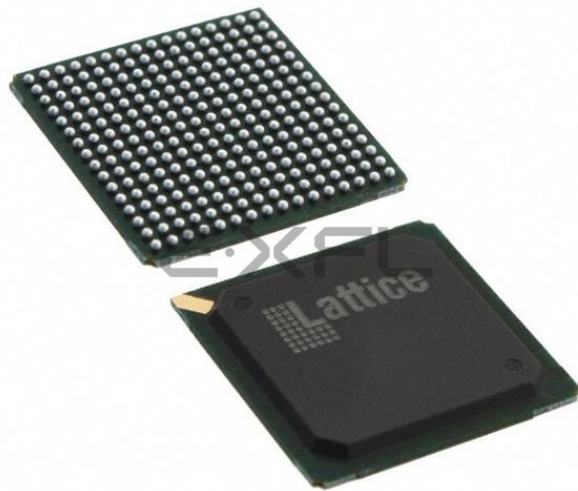




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	4250
Number of Logic Elements/Cells	34000
Total RAM Bits	2151424
Number of I/O	140
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m35se-5f256c

Delay Locked Loops (DLL)

In addition to PLLs, the LatticeECP2/M family of devices has two DLLs per device.

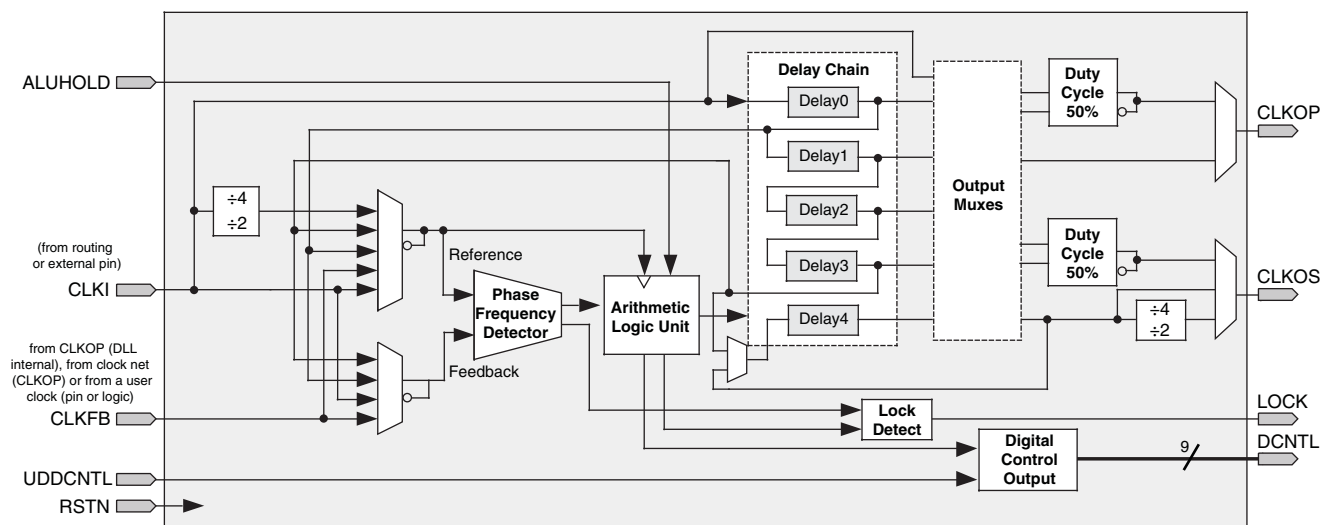
CLKI is the input frequency (generated either from the pin or routing) for the DLL. CLKI feeds into the output muxes block to bypass the DLL, directly to the DELAY CHAIN block and (directly or through divider circuit) to the reference input of the Phase Frequency Detector (PFD) input mux. The reference signal for the PFD can also be generated from the Delay Chain and CLKFB signals. The feedback input to the PFD is generated from the CLKFB pin, CLKI or from tapped signal from the Delay chain.

The PFD produces a binary number proportional to the phase and frequency difference between the reference and feedback signals. This binary output of the PFD is fed into a Arithmetic Logic Unit (ALU). Based on these inputs, the ALU determines the correct digital control codes to send to the delay chain in order to better match the reference and feedback signals. This digital code from the ALU is also transmitted via the Digital Control bus (DCNTL) bus to its associated DLLDELA delay block. The ALUHOLD input allows the user to suspend the ALU output at its current value. The UDDCNTL signal allows the user to latch the current value on the DCNTL bus.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. Both the CLKOS and CLKOP outputs are available with optional duty cycle correction. Divide by two and divide by four frequencies are available at CLKOS. The LOCK output signal is asserted when the DLL is locked. Figure 2-6 shows the DLL block diagram and Table 2-5 provides a description of the DLL inputs and outputs.

The user can configure the DLL for many common functions such as time reference delay mode and clock injection removal mode. Lattice provides primitives in its design tools for these functions. For more information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-6. Delay Locked Loop Diagram (DLL)



- MULT (Multiply)
- MAC (Multiply, Accumulate)
- MULTADDSUB (Multiply, Addition/Subtraction)
- MULTADDSUBSUM (Multiply, Addition/Subtraction, Accumulate)

The number of elements available on each block depends in the width selected from the three available options x9, x18, and x36. A number of these elements are concatenated for highly parallel implementations of DSP functions. Table 2-7 shows the capabilities of the block.

Table 2-7. Maximum Number of Elements in a Block

Width of Multiply	x9	x18	x36
MULT	8	4	1
MAC	2	2	—
MULTADDSUB	4	2	—
MULTADDSUBSUM	2	1	—

Some options are available in four elements. The input register in all the elements can be directly loaded or can be loaded as a shift register from previous operand registers. By selecting “dynamic operation” the following operations are possible:

- In the ‘Signed/Unsigned’ options the operands can be switched between signed and unsigned on every cycle.
- In the ‘Add/Sub’ option the Accumulator can be switched between addition and subtraction on every cycle.
- The loading of operands can switch between parallel and serial operations.

MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-23 shows the MULT sysDSP element.

Figure 2-23. MULT sysDSP Element

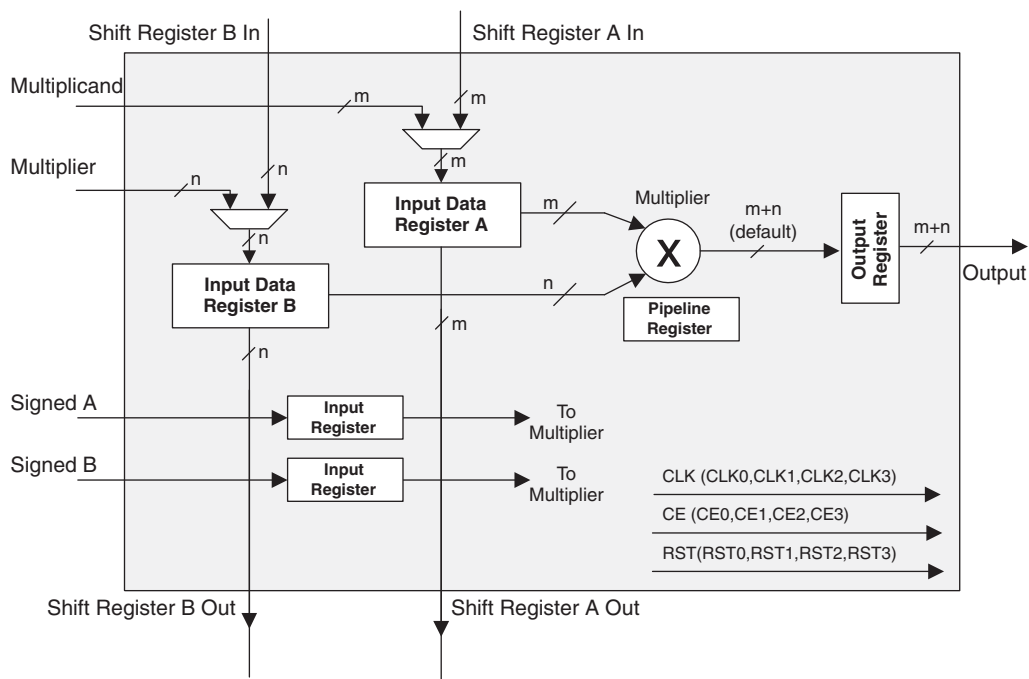


Table 2-12. PIO Signals List

Name	Type	Description
CE0, CE1	Control from the core	Clock enables for input and output block flip-flops
CLK0, CLK1	Control from the core	System clocks for input and output blocks
ECLK1, ECLK2	Control from the core	Fast edge clocks
LSR	Control from the core	Local Set/Reset
GSRN	Control from routing	Global Set/Reset (active low)
INCK ²	Input to the core	Input to Primary Clock Network or PLL reference inputs
DQS	Input to PIO	DQS signal from logic (routing) to PIO
INDD	Input to the core	Unregistered data input to core
INFF	Input to the core	Registered input on positive edge of the clock (CLK0)
IPOS0, IPOS1	Input to the core	Double data rate registered inputs to the core
QPOS0 ¹ , QPOS1 ¹	Input to the core	Gearbox pipelined inputs to the core
QNEG0 ¹ , QNEG1 ¹	Input to the core	Gearbox pipelined inputs to the core
OPOS0, ONEG0, OPOS2, ONEG2	Output data from the core	Output signals from the core for SDR and DDR operation
OPOS1 ONEG1	Tristate control from the core	Signals to Tristate Register block for DDR operation
DEL[3:0]	Control from the core	Dynamic input delay control bits
TD	Tristate control from the core	Tristate signal from the core used in SDR operation
DDRCLKPOL	Control from clock polarity bus	Controls the polarity of the clock (CLK0) that feed the DDR input block
DQSXFER	Control from core	Controls signal to the Output block

1. Signals available on left/right/bottom only.

2. Selected I/O.

PIO

The PIO contains four blocks: an input register block, output register block, tristate register block and a control logic block. These blocks contain registers for operating in a variety of modes along with the necessary clock and selection logic.

Input Register Block

The input register blocks for PIOs in left, right and bottom edges contain delay elements and registers that can be used to condition high-speed interface signals, such as DDR memory interfaces and source synchronous interfaces, before they are passed to the device core. Figure 2-29 shows the diagram of the input register block for left, right and bottom edges. The input register block for the top edge contains one memory element to register the input signal as shown in Figure 2-30. The following description applies to the input register block for PIOs in the left, right and bottom edges of the device.

Input signals are fed from the sysI/O buffer to the input register block (as signal DI). If desired, the input signal can bypass the register and delay elements and be used directly as a combinatorial signal (INDD), a clock (INCK) and, in selected blocks, the input to the DQS delay block. If an input delay is desired, designers can select either a fixed delay or a dynamic delay DEL[3:0]. The delay, if selected, reduces input register hold time requirements when using a global clock.

The input block allows three modes of operation. In the single data rate (SDR) the data is registered, by one of the registers in the single data rate sync register block, with the system clock. In DDR Mode, two registers are used to sample the data on the positive and negative edges of the DQS signal, creating two data streams, D0 and D1. These two data streams are synchronized with the system clock before entering the core. Further discussion on this topic is in the DDR Memory section of this data sheet.

for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm $\pm 1\%$ value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

Non-Encrypted Mode CCLK (MHz)			Encrypted Mode CCLK (MHz)
2.5 ¹	13.0	45.0	2.5 ¹
4.3	15.0	55.0	5.4
5.4	20.0	60.0	10.0
6.9	26.0	—	—
8.1	30.0	—	—
9.2	34.0	—	—
10.0	41.0	130.0	—

1. Software default frequency.

Density Shifting

The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

sysI/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL}^1 (mA)	I_{OH}^1 (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVTTTL	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.8	-0.3	$0.35 V_{CCIO}$	$0.65 V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	16, 12, 8, 4	-16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.5	-0.3	$0.35 V_{CCIO}$	$0.65 V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	8, 4	-8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.2	-0.3	$0.35 V_{CC}$	$0.65 V_{CC}$	3.6	0.4	$V_{CCIO} - 0.4$	6, 2	-6, -2
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
PCI	-0.3	$0.3 V_{CCIO}$	$0.5 V_{CCIO}$	3.6	$0.1 V_{CCIO}$	$0.9 V_{CCIO}$	1.5	-0.5
SSTL3 Class I	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.7	$V_{CCIO} - 1.1$	8	-8
SSTL3 Class II	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.5	$V_{CCIO} - 0.9$	16	-16
SSTL2 Class I	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.54	$V_{CCIO} - 0.62$	7.6	-7.6
							12	-12
SSTL2 Class II	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.35	$V_{CCIO} - 0.43$	15.2	-15.2
							20	-20
SSTL18 Class I	-0.3	$V_{REF} - 0.125$	$V_{REF} + 0.125$	3.6	0.4	$V_{CCIO} - 0.4$	6.7	-6.7
SSTL18 Class II	-0.3	$V_{REF} - 0.125$	$V_{REF} + 0.125$	3.6	0.28	$V_{CCIO} - 0.28$	8	-8
							11	-11
HSTL Class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	4	-4
							8	-8
HSTL18 Class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	8	-8
							12	-12
HSTL18 Class II	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	16	-16

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed $n * 8\text{mA}$, where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

Typical Building Block Function Performance¹

Pin-to-Pin Performance (LVCMOS25 12mA Drive)

Function	-7 Timing	Units
Basic Functions		
16-bit Decoder	3.8	ns
32-bit Decoder	4.5	ns
64-bit Decoder	5.0	ns
4:1 MUX	3.2	ns
8:1 MUX	3.4	ns
16:1 MUX	3.5	ns
32:1 MUX	4.0	ns

1. These timing numbers were generated using the ispLEVER 8.0 design tool. Exact performance may vary with device and tool version. The tool uses internal parameters that have been characterized but are not tested on every device.

Register-to-Register Performance

Function	-7 Timing	Units
Basic Functions		
16-bit Decoder	599	MHz
32-bit Decoder	542	MHz
64-bit Decoder	417	MHz
4:1 MUX	847	MHz
8:1 MUX	803	MHz
16:1 MUX	660	MHz
32:1 MUX	577	MHz
8-bit Adder	591	MHz
16-bit Adder	500	MHz
64-bit Adder	306	MHz
16-bit Counter	488	MHz
32-bit Counter	378	MHz
64-bit Counter	260	MHz
64-bit Accumulator	253	MHz
Embedded Memory Functions		
512x36 Single Port RAM, EBR Output Registers	370	MHz
1024x18 True-Dual Port RAM (Write Through or Normal, EBR Output Registers)	370	MHz
1024x18 True-Dual Port RAM (Write Through or Normal, PLC Output Registers)	280	MHz
Distributed Memory Functions		
16x4 Pseudo-Dual Port RAM (One PFU)	819	MHz
32x4 Pseudo-Dual Port RAM	521	MHz
64x8 Pseudo-Dual Port RAM	435	MHz
DSP Functions		
18x18 Multiplier (All Registers)	420	MHz
9x9 Multiplier (All Registers)	420	MHz

LatticeECP2/M sysCONFIG Port Timing Specifications (Continued)

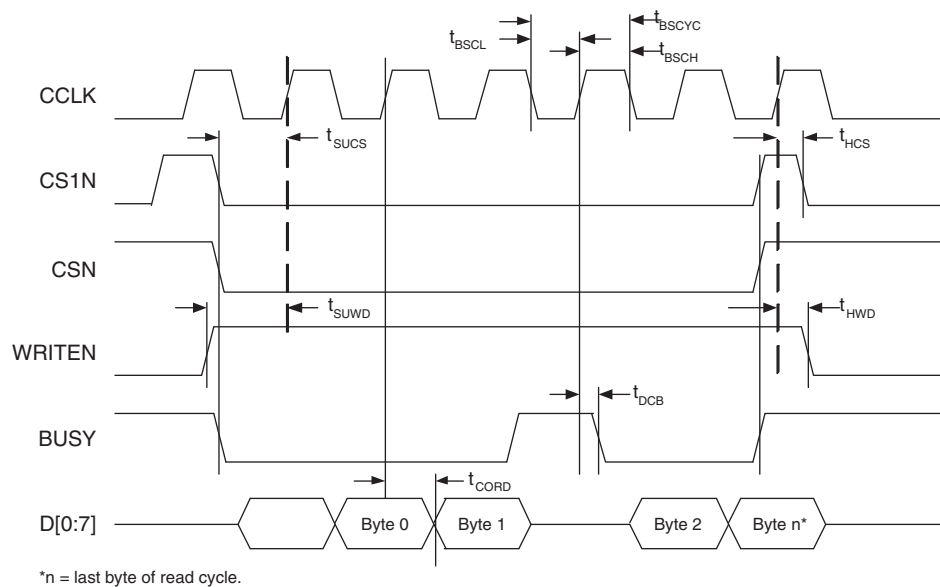
Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
f_{MAXSPI}	Max. CCLK Frequency - SPI Flash Read Opcode (0x03) (SPIFASTN = 1)	—	20	MHz
	Max. CCLK Frequency - SPI Flash Fast Read Opcode (0x0B) (SPIFASTN = 0)	—	50	MHz
	Max. CCLK Frequency - Encrypted Bitstream	—	10	MHz
t_{SUSPI}	SOSPI Data Setup Time Before CCLK	7	—	ns
t_{HSPI}	SOSPI Data Hold Time After CCLK	2	—	ns
t_{SUMCDI}	DI Setup to CCLK	7	—	ns
t_{HMCDI}	DI Hold from CCLK	1	—	ns

1. Re-toggling the PROGRAMN pin is not permitted until the INITN pin is high. Avoid consecutive toggling of the PROGRAMN.
2. For SED (Soft Error Detect), the SEDCLKIN operating frequency must be at least 20MHz. SEDCLKIN is derived from Master Clock Frequency that has a +/-30% variation..

Parameter	Min.	Max.	Units
Master Clock Frequency	Selected value - 30%	Selected value + 30%	MHz
Duty Cycle	40	60	%

Figure 3-14. sysCONFIG Parallel Port Read Cycle



LatticeECP2M Power Supply and NC (Cont.)

Signal	1152 fpBGA
V _{CC}	AA13, AA14, AA15, AA16, AA17, AA18, AA19, AA20, AA21, AA22, AB14, AB15, AB20, AB21, N14, N15, N20, N21, P13, P14, P15, P16, P17, P18, P19, P20, P21, P22, R13, R14, R21, R22, T14, T21, U14, U21, V14, V21, W14, W21, Y13, Y14, Y21, Y22
V _{CCIO0}	C12, C16, E14, H12, H16, M14, M15
V _{CCIO1}	C19, C23, E21, H19, H23, M20, M21
V _{CCIO2}	G32, K28, K32, N27, N32, P23, R23, T27, T32
V _{CCIO3}	AA23, AB27, AB32, AE28, AE32, AH32, W27, W32, Y23
V _{CCIO4}	AC20, AC21, AG19, AG23, AK21, AM19, AM23
V _{CCIO5}	AC14, AC15, AG12, AG16, AK14, AM12, AM16
V _{CCIO6}	AA12, AB3, AB8, AE3, AE7, AH3, W3, W8, Y12
V _{CCIO7}	G3, K3, K7, N3, N8, P12, R12, T3, T8
V _{CCIO8}	AD28, AG32
V _{CCJ}	AK3
V _{CCAUX}	AB12, AB13, AB22, AB23, AC13, AC22, M13, M22, N12, N13, N22, N23
V _{CCPLL}	R15, R20, Y15, Y20
SERDES Power ³	D7, B9, B8, D9, B7, E7, B6, D8, E6, D6, D4, B5, D3, B4, C1, B3, B1, B2, B33, B34, B32, C34, B31, D32, B30, D31, E29, D29, D27, B29, E28, B28, D26, B27, B26, D28, AL28, AN26, AN27, AL26, AN28, AK28, AN29, AL27, AL29, AK29, AL31, AN30, AL32, AN31, AM34, AN32, AN34, AN33, AN2, AN1, AN3, AM1, AN4, AL3, AN5, AL4, AL6, AK6, AL8, AN6, AK7, AN7, AL9, AN8, AN9, AL7
GND ¹	A1, A10, A13, A22, A25, A34, AB16, AB17, AB18, AB19, AB26, AB31, AB4, AB9, AC16, AC17, AC18, AC19, AD27, AE27, AE31, AE4, AE8, AF12, AF16, AF19, AF23, AG31, AH31, AH4, AJ14, AJ21, AK27, AK8, AL10, AL16, AL19, AL2, AL25, AL33, AP1, AP10, AP13, AP22, AP25, AP34, D10, D16, D19, D2, D25, D33, E27, E8, F14, F21, G31, G4, J12, J16, J19, J23, K27, K31, K4, K8, M16, M17, M18, M19, N16, N17, N18, N19, N26, N31, N4, N9, R16, R17, R18, R19, T12, T13, T15, T16, T17, T18, T19, T20, T22, T23, T26, T31, T4, T9, U12, U13, U15, U16, U17, U18, U19, U20, U22, U23, V12, V13, V15, V16, V17, V18, V19, V20, V22, V23, W12, W13, W15, W16, W17, W18, W19, W20, W22, W23, W26, W31, W4, W9, Y16, Y17, Y18, Y19
NC ²	LFE2M70: H2, H1, G5, G6, M9, M10, H3, H4, P3, P4, P9, M7, P1, P2, N7, P7, AC7, AC5, AC6, AD5, AD4, AD3, AD10, AD8, AD2, AD1, AD9, AC11, AD6, AD7, AE1, AE2, AJ12, AH12, AL13, AK13, AE14, AG13, AH22, AH21, AG22, AG21, AF33, AF34, AC27, AC28, AD29, AD30, AE33, AE34, AD32, AD31, AB25, AC25, AB28, AA26, AD33, AD34, P30, P29, P31, P32, R25, T24, N34, N33, F24, G23, J22, G22, H21, K21, L19, L20, L18, K19, J14, L15, H14, K14, F12, D11, F11, E11, A11, A12, A23, A24, AA11, AB11, AC26, AC30, AD11, AD12, AD13, AD14, AD15, AD19, AD21, AD22, AD23, AE10, AE11, AE12, AE13, AE19, AE21, AE22, AE23, AF11, AF21, AF22, AF24, AF8, AF9, AG10, AG11, AG24, AG25, AG26, AG3, AG7, AG8, AG9, AH10, AH11, AH13, AH24, AH25, AH26, AH27, AH5, AH6, AH7, AH8, AH9, AJ10, AJ11, AJ13, AJ24, AJ25, AJ26, AJ27, AJ3, AJ4, AJ5, AJ6, AJ7, AJ8, AJ9, AK10, AK11, AK12, AK24, AK25, AK26, AK4, AK9, AL11, AL12, AL34, AM10, AM11, AM13, AM25, AN10, AN11, AN12, AN13, AN24, AN25, AP11, AP12, AP24, B10, B11, B12, B13, B22, B23, B24, B25, C10, C11, C13, C22, C24, C25, D1, D15, D24, D34, E10, E24, E25, E26, E3, E31, E32, E33, E34, E4, E9, F10, F25, F26, F27, F28, F29, F30, F31, F32, F33, F34, F5, F6, F7, F8, F9, G10, G11, G24, G25, G26, G27, G28, G29, G30, G33, G34, G7, G8, G9, H10, H11, H24, H25, H26, H27, H28, H29, H8, H9, J10, J11, J24, J25, J26, J9, K10, K11, K12, K13, K23, K24, K25, K26, L11, L12, L13, L14, L21, L22, L23, L24, L25, L26, M11, M24, M25, M6, M8, N10, N11, P10, P25, P26, R9, T11, U11, W11, Y10, Y11 LFE2M100: A11, A12, A23, A24, AA11, AB11, AC26, AC30, AD11, AD12, AD13, AD14, AD15, AD19, AD21, AD22, AD23, AE10, AE11, AE12, AE13, AE19, AE21, AE22, AE23, AF11, AF21, AF22, AF24, AF8, AF9, AG10, AG11, AG24, AG25, AG26, AG3, AG7, AG8, AG9, AH10, AH11, AH13, AH24, AH25, AH26, AH27, AH5, AH6, AH7, AH8, AH9, AJ10, AJ11, AJ13, AJ24, AJ25, AJ26, AJ27, AJ3, AJ4, AJ5, AJ6, AJ7, AJ8, AJ9, AK10, AK11, AK12, AK24, AK25, AK26, AK4, AK9, AL11, AL12, AL34, AM10, AM11, AM13, AM25, AN10, AN11, AN12, AN13, AN24, AN25, AP11, AP12, AP24, B10, B11, B12, B13, B22, B23, B24, B25, C10, C11, C13, C22, C24, C25, D1, D15, D24, D34, E10, E24, E25, E26, E3, E31, E32, E33, E34, E4, E9, F10, F25, F26, F27, F28, F29, F30, F31, F32, F33, F34, F5, F6, F7, F8, F9, G10, G11, G24, G25, G26, G27, G28, G29, G30, G33, G34, G7, G8, G9, H10, H11, H24, H25, H26, H27, H28, H29, H8, H9, J10, J11, J24, J25, J26, J9, K10, K11, K12, K13, K23, K24, K25, K26, L11, L12, L13, L14, L21, L22, L23, L24, L25, L26, M11, M24, M25, M6, M8, N10, N11, P10, P25, P26, R9, T11, U11, W11, Y10, Y11

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. For package migration across device densities, the designer must comprehend the package pin requirements for the SERDES blocks. Specifically, the SERDES power pins of the largest density device must be accounted to accommodate migration to other smaller devices using the same package. Please refer to TN1160, [LatticeECP2/M Density Migration](#) for more details.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
92	PB44A	4	BDQ42	T	PB54A	4	BDQ51	T	
93	VCCIO4	4			VCCIO4	4			
94	PB44B	4	BDQ42	C	PB54B	4	BDQ51	C	
95	PB48A	4	BDQ51	T	PB58A	4	BDQ60	T	
96	PB48B	4	BDQ51	C	PB58B	4	BDQ60	C	
97	VCC	-			VCC	-			
98	PB52A	4	BDQ51	T	PB60A	4	BDQS60	T	
99	PB52B	4	BDQ51	C	PB60B	4	BDQ60	C	
100	VCCIO4	4			VCCIO4	4			
101	PB54A	4	BDQ51		PB63A	4	BDQ60		
102	GND	-			GND	-			
103	PB55A	4	VREF2_4/BDQ51	T	PB64A	4	VREF2_4/BDQ60	T	
104	PB55B	4	VREF1_4/BDQ51	C	PB64B	4	VREF1_4/BDQ60	C	
105	CFG1	8			CFG1	8			
106	PROGRAMN	8			PROGRAMN	8			
107	CFG2	8			CFG2	8			
108	INITN	8			INITN	8			
109	CFG0	8			CFG0	8			
110	CCLK	8			CCLK	8			
111	DONE	8			DONE	8			
112	PR29A	8	D0/SPIFASTN		PR43A	8	D0/SPIFASTN		
113	VCCIO8	8			VCCIO8	8			
114	PR26A	8	D6		PR40A	8	D6		
115	GND	-			GND	-			
116	VCC	-			VCC	-			
117	PR25B	8	D7/SPID0	C	PR39B	8	D7/SPID0	C	
118	VCCIO8	8			VCCIO8	8			
119	PR25A	8	DI/CSSPI0N	T	PR39A	8	DI/CSSPI0N	T	
120	PR24B	8	DOU/CSON	C	PR38B	8	DOU/CSON	C	
121	PR24A	8	BUSY/SISPI	T	PR38A	8	BUSY/SISPI	T	
122	GND	-			GND	-			
123	VCCIO3	3			VCCIO3	3			
124	PR21A	3	RLM0_GPLLT_FB_A		PR31A	3	RLM0_GPLLT_FB_A/RDQ34		
125	VCCAUX	-			VCCAUX	-			
126	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*	
127	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	PR30A	3	RLM0_GPLL_T_IN_A**/RDQ34	T (LVDS)*	
128	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
129	VCC	-			VCC	-			
130	PR18B	3	RLM0_GDLL_C_FB_A	C	PR28B	3	RLM0_GDLL_C_FB_A/RDQ25	C	
131	PR18A	3	RLM0_GDLL_T_FB_A	T	PR28A	3	RLM0_GDLL_T_FB_A/RDQ25	T	
132	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	PR27B	3	RLM0_GDLL_C_IN_A**/RDQ25	C (LVDS)*	
133	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	PR27A	3	RLM0_GDLL_T_IN_A**/RDQ25	T (LVDS)*	
134	PR16B	3	VREF2_3	C	PR22B	3	VREF2_3/RDQ25	C	
135	VCCIO3	3			VCCIO3	3			
136	PR16A	3	VREF1_3	T	PR22A	3	VREF1_3/RDQ25	T	
137	PR15B	3	PCLKC3_0	C (LVDS)*	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*	

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C2	PT3A	0		T	PT3A	0		T	
J10	VCC	-			VCC	-			
J11	VCC	-			VCC	-			
J12	VCC	-			VCC	-			
J13	VCC	-			VCC	-			
K14	VCC	-			VCC	-			
K9	VCC	-			VCC	-			
L14	VCC	-			VCC	-			
L9	VCC	-			VCC	-			
M14	VCC	-			VCC	-			
M9	VCC	-			VCC	-			
N14	VCC	-			VCC	-			
N9	VCC	-			VCC	-			
P10	VCC	-			VCC	-			
P11	VCC	-			VCC	-			
P12	VCC	-			VCC	-			
P13	VCC	-			VCC	-			
G10	VCCIO0	0			VCCIO0	0			
G9	VCCIO0	0			VCCIO0	0			
H9	VCCIO0	0			VCCIO0	0			
H8	VCCIO0	0			VCCIO0	0			
G11	VCCIO1	1			VCCIO1	1			
G12	VCCIO1	1			VCCIO1	1			
G13	VCCIO1	1			VCCIO1	1			
G14	VCCIO1	1			VCCIO1	1			
H14	VCCIO2	2			VCCIO2	2			
H15	VCCIO2	2			VCCIO2	2			
J15	VCCIO2	2			VCCIO2	2			
K16	VCCIO2	2			VCCIO2	2			
L16	VCCIO3	3			VCCIO3	3			
M16	VCCIO3	3			VCCIO3	3			
N16	VCCIO3	3			VCCIO3	3			
P16	VCCIO3	3			VCCIO3	3			
R14	VCCIO4	4			VCCIO4	4			
T12	VCCIO4	4			VCCIO4	4			
T13	VCCIO4	4			VCCIO4	4			
T14	VCCIO4	4			VCCIO4	4			
R9	VCCIO5	5			VCCIO5	5			
T10	VCCIO5	5			VCCIO5	5			
T11	VCCIO5	5			VCCIO5	5			
T9	VCCIO5	5			VCCIO5	5			
N7	VCCIO6	6			VCCIO6	6			
P7	VCCIO6	6			VCCIO6	6			
P8	VCCIO6	6			VCCIO6	6			

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U3	PL55A	6	LDQ56	T	PL74A	6	LDQ75	T
U4	PL55B	6	LDQ56	C	PL74B	6	LDQ75	C
GNDIO	GNDIO6	-			GNDIO6	-		
Y1	PL56A	6	LDQS56	T (LVDS)*	PL75A	6	LDQS75	T (LVDS)*
W1	PL56B	6	LDQ56	C (LVDS)*	PL75B	6	LDQ75	C (LVDS)*
R7	PL57A	6	LDQ56	T	PL76A	6	LDQ75	T
VCCIO	VCCIO6	6			VCCIO	6		
T7	PL57B	6	LDQ56	C	PL76B	6	LDQ75	C
V4	PL58A	6	LDQ56	T (LVDS)*	PL77A	6	LDQ75	T (LVDS)*
V3	PL58B	6	LDQ56	C (LVDS)*	PL77B	6	LDQ75	C (LVDS)*
AA2	PL59A	6	LDQ56	T	PL78A	6	LDQ75	T
GNDIO	GNDIO6	-			GNDIO6	-		
AA1	PL59B	6	LDQ56	C	PL78B	6	LDQ75	C
U7	TCK	-			TCK	-		
U5	TDI	-			TDI	-		
V5	TMS	-			TMS	-		
V6	TDO	-			TDO	-		
T8	VCCJ	-			VCCJ	-		
Y3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
Y2	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
W4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
W3	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
W5	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
W6	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO	5		
AB3	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
AB2	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
GNDIO	GNDIO5	-			GNDIO5	-		
Y4	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
AA3	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
AB5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
AB4	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
AA5	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
Y5	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO	5		
AB6	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T
AA6	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C
GNDIO	GNDIO5	-			GNDIO5	-		
VCCIO	VCCIO5	5			VCCIO	5		
W7	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T
W8	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C
Y6	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T
Y7	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C
AA7	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO	5		
AB7	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
J10	VCC	-			VCC	-		
J11	VCC	-			VCC	-		
J12	VCC	-			VCC	-		
J13	VCC	-			VCC	-		
K14	VCC	-			VCC	-		
K9	VCC	-			VCC	-		
L14	VCC	-			VCC	-		
L9	VCC	-			VCC	-		
M14	VCC	-			VCC	-		
M9	VCC	-			VCC	-		
N14	VCC	-			VCC	-		
N9	VCC	-			VCC	-		
P10	VCC	-			VCC	-		
P11	VCC	-			VCC	-		
P12	VCC	-			VCC	-		
P13	VCC	-			VCC	-		
G5	VCCAUX	-			VCCAUX	0		
K5	VCCAUX	-			VCCAUX	0		
R5	VCCAUX	-			VCCAUX	1		
V7	VCCAUX	-			VCCAUX	1		
V11	VCCAUX	-			VCCAUX	2		
V8	VCCAUX	-			VCCAUX	2		
V13	VCCAUX	-			VCCAUX	3		
V15	VCCAUX	-			VCCAUX	3		
M17	VCCAUX	-			VCCAUX	4		
P17	VCCAUX	-			VCCAUX	4		
E17	VCCAUX	-			VCCAUX	5		
G18	VCCAUX	-			VCCAUX	5		
D11	VCCAUX	-			VCCAUX	6		
F13	VCCAUX	-			VCCAUX	6		
C5	VCCAUX	-			VCCAUX	7		
E6	VCCAUX	-			VCCAUX	7		
G10	VCCIO0	0			VCCIO0	0		
G9	VCCIO0	0			VCCIO0	0		
H8	VCCIO0	0			VCCIO0	0		
H9	VCCIO0	0			VCCIO0	0		
G11	VCCIO1	1			VCCIO1	1		
G12	VCCIO1	1			VCCIO1	1		
G13	VCCIO1	1			VCCIO1	1		
G14	VCCIO1	1			VCCIO1	1		
H14	VCCIO2	2			VCCIO2	2		
H15	VCCIO2	2			VCCIO2	2		
J15	VCCIO2	2			VCCIO2	2		
K16	VCCIO2	2			VCCIO2	2		
L16	VCCIO3	3			VCCIO3	3		
M16	VCCIO3	3			VCCIO3	3		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
U1	PL53A	6	LDQ50	T	PL66A	6	LDQ63	T	
V1	PL53B	6	LDQ50	C	PL66B	6	LDQ63	C	
GND	GNDIO6	-			GNDIO6	-			
P3	PL54A	6	LDQ58	T (LVDS)*	PL67A	6	LDQ71	T (LVDS)*	
R3	PL54B	6	LDQ58	C (LVDS)*	PL67B	6	LDQ71	C (LVDS)*	
R4	PL55A	6	LDQ58	T	PL68A	6	LDQ71	T	
U2	PL55B	6	LDQ58	C	PL68B	6	LDQ71	C	
VCCIO	VCCIO6	6			VCCIO6	6			
V2	PL56A	6	LDQ58	T (LVDS)*	PL69A	6	LDQ71	T (LVDS)*	
W2	PL56B	6	LDQ58	C (LVDS)*	PL69B	6	LDQ71	C (LVDS)*	
T6	PL57A	6	LDQ58	T	PL70A	6	LDQ71	T	
R5	PL57B	6	LDQ58	C	PL70B	6	LDQ71	C	
GND	GNDIO6	-			GNDIO6	-			
R6	PL58A	6	LDQS58	T (LVDS)*	PL71A	6	LDQS71	T (LVDS)*	
R7	PL58B	6	LDQ58	C (LVDS)*	PL71B	6	LDQ71	C (LVDS)*	
W1	PL59A	6	LDQ58	T	PL72A	6	LDQ71	T	
VCCIO	VCCIO6	6			VCCIO6	6			
Y2	PL59B	6	LDQ58	C	PL72B	6	LDQ71	C	
Y1	PL60A	6	LLM0_GDLLT_IN_A**/LDQ58	T (LVDS)*	PL73A	6	LLM0_GDLLT_IN_A**/LDQ71	T (LVDS)*	
AA2	PL60B	6	LLM0_GDLLC_IN_A**/LDQ58	C (LVDS)*	PL73B	6	LLM0_GDLLC_IN_A**/LDQ71	C (LVDS)*	
T5	PL61A	6	LLM0_GDLLT_FB_A/LDQ58	T	PL74A	6	LLM0_GDLLT_FB_A/LDQ71	T	
GND	GNDIO6	-			GNDIO6	-			
T7	PL61B	6	LLM0_GDLLC_FB_D/LDQ58	C	PL74B	6	LLM0_GDLLC_FB_D/LDQ71	C	
R8	VCCPLL	6			VCCPLL	-			
T8	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
U3	PL63A	6	LLM0_GPLLT_IN_A**/LDQ67	T (LVDS)*	PL76A	6	LLM0_GPLLT_IN_A**/LDQ80	T (LVDS)*	
U4	PL63B	6	LLM0_GPLLC_IN_A**/LDQ67	C (LVDS)*	PL76B	6	LLM0_GPLLC_IN_A**/LDQ80	C (LVDS)*	
V3	PL64A	6	LLM0_GPLLT_FB_A/LDQ67	T	PL77A	6	LLM0_GPLLT_FB_A/LDQ80	T	
U5	PL64B	6	LLM0_GPLLC_FB_A/LDQ67	C	PL77B	6	LLM0_GPLLC_FB_A/LDQ80	C	
V4	PL65A	6	LDQ67	T (LVDS)*	PL78A	6	LDQ80	T (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
V5	PL65B	6	LDQ67	C (LVDS)*	PL78B	6	LDQ80	C (LVDS)*	
Y3	PL66A	6	LDQ67	T	PL79A	6	LDQ80	T	
Y4	PL66B	6	LDQ67	C	PL79B	6	LDQ80	C	
W3	PL67A	6	LDQS67	T (LVDS)*	PL80A	6	LDQS80	T (LVDS)*	
GND	GNDIO6	-			GNDIO6	-			
W4	PL67B	6	LDQ67	C (LVDS)*	PL80B	6	LDQ80	C (LVDS)*	
AA1	PL68A	6	LDQ67	T	PL81A	6	LDQ80	T	
AB1	PL68B	6	LDQ67	C	PL81B	6	LDQ80	C	
VCCIO	VCCIO6	6			VCCIO6	6			
U8	PL69A	6	LDQ67	T (LVDS)*	PL82A	6	LDQ80	T (LVDS)*	
U7	PL69B	6	LDQ67	C (LVDS)*	PL82B	6	LDQ80	C (LVDS)*	
V8	PL70A	6	LDQ67	T	PL83A	6	LDQ80	T	
U6	PL70B	6	LDQ67	C	PL83B	6	LDQ80	C	
GND	GNDIO6	-			GNDIO6	-			
W6	PL71A	6	LDQ75	T (LVDS)*	PL84A	6	LDQ88	T (LVDS)*	

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P25	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2		
P23	PR51A	2	RDQ54	T
P27	PR50B	2	RDQ54	C (LVDS)*
P28	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-		
VCCIO	VCCIO2	2		
N24	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
N26	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
N23	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
N25	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2		
P29	PR37B	2	RDQ37	C (LVDS)*
P30	PR37A	2	RDQS37	T (LVDS)*
M26	PR36B	2	RDQ37	C
GND	GNDIO2	-		
M24	PR36A	2	RDQ37	T
N29	PR35B	2	RDQ37	C (LVDS)*
N30	PR35A	2	RDQ37	T (LVDS)*
M25	PR34B	2	RDQ37	C
VCCIO	VCCIO2	2		
M23	PR34A	2	RDQ37	T
M27	PR33B	2	RDQ37	C (LVDS)*
M28	PR33A	2	RDQ37	T (LVDS)*
L26	PR32B	2	RDQ29	C
GND	GNDIO2	-		
L24	PR32A	2	RDQ29	T
M29	PR31B	2	RDQ29	C (LVDS)*
M30	PR31A	2	RDQ29	T (LVDS)*
L25	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2		
L23	PR30A	2	RDQ29	T
L27	PR29B	2	RDQ29	C (LVDS)*
L28	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-		
K24	PR28B	2	RDQ29	C
K26	PR28A	2	RDQ29	T
L29	PR27B	2	RDQ29	C (LVDS)*
L30	PR27A	2	RDQ29	T (LVDS)*
VCCIO	VCCIO2	2		
K23	PR26B	2	RDQ29	C
K25	PR26A	2	RDQ29	T
K27	PR25B	2	RDQ29	C (LVDS)*

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
C2	PL2A	7	LDQ6	T (LVDS)*	PL2A	7	LDQ6	T*	
C1	PL2B	7	LDQ6	C (LVDS)*	PL2B	7	LDQ6	C*	
F6	PL3A	7	LDQ6	T	PL3A	7	LDQ6	T	
H9	PL3B	7	LDQ6	C	PL3B	7	LDQ6	C	
D3	PL4A	7	LDQ6	T (LVDS)*	PL4A	7	LDQ6	T*	
VCCIO	VCCIO7	7			VCCIO7	7			
D2	PL4B	7	LDQ6	C (LVDS)*	PL4B	7	LDQ6	C*	
F5	PL5A	7	LDQ6	T	PL5A	7	LDQ6	T	
H8	PL5B	7	LDQ6	C	PL5B	7	LDQ6	C	
E3	PL6A	7	LDQS6	T (LVDS)*	PL6A	7	LDQS6	T*	
GNDIO	GNDIO7	-			GNDIO7	-			
E2	PL6B	7	LDQ6	C (LVDS)*	PL6B	7	LDQ6	C*	
J9	PL7A	7	LDQ6	T	PL7A	7	LDQ6	T	
E4	PL7B	7	LDQ6	C	PL7B	7	LDQ6	C	
VCCIO	VCCIO7	7			VCCIO7	7			
E1	PL8A	7	LDQ6	T (LVDS)*	PL8A	7	LDQ6	T*	
D1	PL8B	7	LDQ6	C (LVDS)*	PL8B	7	LDQ6	C*	
J8	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7/LDQ6	T	
F4	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7/LDQ6	C	
GNDIO	GNDIO7	-			GNDIO7	-			
-	-	-			VCCIO7	7			
F3	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A	T*	
F1	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A	C*	
G6	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T	PL12A	7	LUM0_SPLLT_FB_A	T	
K9	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	PL12B	7	LUM0_SPLLC_FB_A	C	
-	-	-			GNDIO7	-			
G5	PL13A	7	LDQ15	T (LVDS)*	PL13A	7		T*	
VCCIO	VCCIO7	7			-	-			
G4	PL13B	7	LDQ15	C (LVDS)*	PL13B	7		C*	
H5	PL14A	7	LDQ15	T	PL14A	7		T	
-	-	-			VCCIO7	7			
H6	PL14B	7	LDQ15	C	PL14B	7		C	
GNDIO	GNDIO7	-			GNDIO7	-			
J7	PL16A	7	LDQ15	T	PL19A	7		T	
H4	PL16B	7	LDQ15	C	PL19B	7		C	
H3	PL17A	7	LDQ15	T (LVDS)*	PL20A	7		T*	
VCCIO	VCCIO7	7			VCCIO7	7			
G3	PL17B	7	LDQ15	C (LVDS)*	PL20B	7		C*	
GNDIO	GNDIO7	-			GNDIO7	-			
G1	PL19A	7	LDQ23	T (LVDS)*	PL23A	7	LDQ27	T*	
H1	PL19B	7	LDQ23	C (LVDS)*	PL23B	7	LDQ27	C*	
J3	PL20A	7	LDQ23	T	PL24A	7	LDQ27	T	
J4	PL20B	7	LDQ23	C	PL24B	7	LDQ27	C	
VCCIO	VCCIO7	7			VCCIO7	7			
H2	PL21A	7	LDQ23	T (LVDS)*	PL25A	7	LDQ27	T*	
J2	PL21B	7	LDQ23	C (LVDS)*	PL25B	7	LDQ27	C*	
K7	PL22A	7	LDQ23	T	PL26A	7	LDQ27	T	
J6	PL22B	7	LDQ23	C	PL26B	7	LDQ27	C	

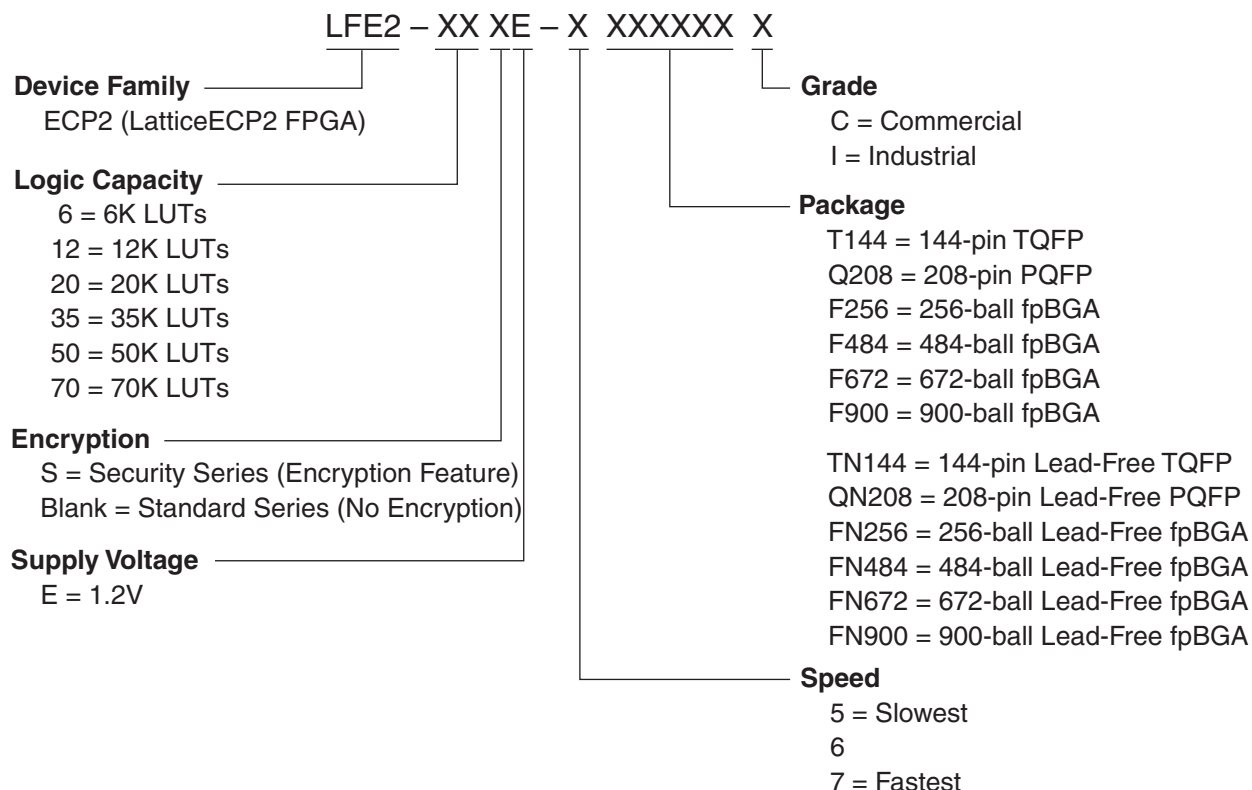
LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AA8	PL65A	6	LDQ64	T	PL73A	6	LDQ72	T
VCCIO	VCCIO6	6			VCCIO6	6		
Y9	PL65B	6	LDQ64	C	PL73B	6	LDQ72	C
AA6	PL66A	6	LDQ64	T (LVDS)*	PL74A	6	LDQ72	T (LVDS)*
AA7	PL66B	6	LDQ64	C (LVDS)*	PL74B	6	LDQ72	C (LVDS)*
AA4	PL67A	6	LDQ64	T	PL75A	6	LDQ72	T
GNDIO	GNDIO6	-			GNDIO6	-		
AA3	PL67B	6	LDQ64	C	PL75B	6	LDQ72	C
AA9	PL69A	6	LDQ73	T (LVDS)*	PL77A	6	LDQ81	T (LVDS)*
AA10	PL69B	6	LDQ73	C (LVDS)*	PL77B	6	LDQ81	C (LVDS)*
AA5	PL70A	6	LDQ73	T	PL78A	6	LDQ81	T
AB6	PL70B	6	LDQ73	C	PL78B	6	LDQ81	C
AB1	PL71A	6	LDQ73	T (LVDS)*	PL79A	6	LDQ81	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
AB2	PL71B	6	LDQ73	C (LVDS)*	PL79B	6	LDQ81	C (LVDS)*
AC8	PL72A	6	LDQ73	T	PL80A	6	LDQ81	T
AB10	PL72B	6	LDQ73	C	PL80B	6	LDQ81	C
AC1	PL73A	6	LDQS73	T (LVDS)*	PL81A	6	LDQS81	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
AC2	PL73B	6	LDQ73	C (LVDS)*	PL81B	6	LDQ81	C (LVDS)*
AB7	PL74A	6	LDQ73	T	PL82A	6	LDQ81	T
AB5	PL74B	6	LDQ73	C	PL82B	6	LDQ81	C
VCCIO	VCCIO6	6			VCCIO6	6		
AC3	PL75A	6	LDQ73	T (LVDS)*	PL83A	6	LDQ81	T (LVDS)*
AC4	PL75B	6	LDQ73	C (LVDS)*	PL83B	6	LDQ81	C (LVDS)*
AC10	PL76A	6	LDQ73	T	PL84A	6	LDQ81	T
AC9	PL76B	6	LDQ73	C	PL84B	6	LDQ81	C
GNDIO	GNDIO6	-			GNDIO6	-		
AC7	NC	-			PL86A	6	LDQ90	T (LVDS)*
AC5	NC	-			PL86B	6	LDQ90	C (LVDS)*
AC6	NC	-			PL87A	6	LDQ90	T
AD5	NC	-			PL87B	6	LDQ90	C
-	-	-			VCCIO6	6		
AD4	NC	-			PL88A	6	LDQ90	T (LVDS)*
AD3	NC	-			PL88B	6	LDQ90	C (LVDS)*
AD10	NC	-			PL89A	6	LDQ90	T
AD8	NC	-			PL89B	6	LDQ90	C
-	-	-			GNDIO6	-		
AD2	NC	-			PL90A	6	LDQS90	T (LVDS)*
AD1	NC	-			PL90B	6	LDQ90	C (LVDS)*
AD9	NC	-			PL91A	6	LDQ90	T
-	-	-			VCCIO6	6		
AC11	NC	-			PL91B	6	LDQ90	C
AD6	NC	-			PL92A	6	LDQ90	T (LVDS)*
AD7	NC	-			PL92B	6	LDQ90	C (LVDS)*
AE1	NC	-			PL93A	6	LDQ90	T
-	-	-			GNDIO6	-		
AE2	NC	-			PL93B	6	LDQ90	C
AF2	PL78A	6	LDQ82	T (LVDS)*	PL95A	6	LDQ99	T (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

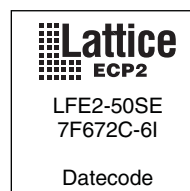
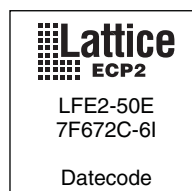
LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AL8	LLC_SQ_VCCIB1	14			LLC_SQ_VCCIB1	14		
AM7	LLC_SQ_HDINN1	14		C	LLC_SQ_HDINN1	14		C
AN6	LLC_SQ_VCCRX1	14			LLC_SQ_VCCRX1	14		
AP6	LLC_SQ_HDOUTP1	14		T	LLC_SQ_HDOUTP1	14		T
AK7	LLC_SQ_VCCOB1	14			LLC_SQ_VCCOB1	14		
AP7	LLC_SQ_HDOUTN1	14		C	LLC_SQ_HDOUTN1	14		C
AN7	LLC_SQ_VCCTX1	14			LLC_SQ_VCCTX1	14		
AP8	LLC_SQ_HDOUTN0	14		C	LLC_SQ_HDOUTN0	14		C
AL9	LLC_SQ_VCCOB0	14			LLC_SQ_VCCOB0	14		
AP9	LLC_SQ_HDOUTP0	14		T	LLC_SQ_HDOUTP0	14		T
AN8	LLC_SQ_VCCTX0	14			LLC_SQ_VCCTX0	14		
AM8	LLC_SQ_HDINN0	14		C	LLC_SQ_HDINN0	14		C
AN9	LLC_SQ_VCCIB0	14			LLC_SQ_VCCIB0	14		
AM9	LLC_SQ_HDINP0	14		T	LLC_SQ_HDINP0	14		T
AL7	LLC_SQ_VCCRX0	14			LLC_SQ_VCCRX0	14		
-	-	-			VCCIO5	5		
AJ12	NC	-			PB32A	5	BDQ33	T
AH12	NC	-			PB32B	5	BDQ33	C
-	-	-			GNDIO5	-		
-	-	-			VCCIO5	5		
AL13	NC	-			PB36A	5	BDQ33	T
AK13	NC	-			PB36B	5	BDQ33	C
-	-	-			GNDIO5	-		
AE14	NC	-			PB38A	5	BDQ42	T
AG13	NC	-			PB38B	5	BDQ42	C
AN14	PB30A	5	BDQ33	T	PB39A	5	BDQ42	T
AP14	PB30B	5	BDQ33	C	PB39B	5	BDQ42	C
AH14	PB31A	5	BDQ33	T	PB40A	5	BDQ42	T
AJ15	PB31B	5	BDQ33	C	PB40B	5	BDQ42	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
AL14	PB33A	5	BDQS33	T	PB42A	5	BDQS42	T
AM14	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C
AF14	PB35A	5	BDQ33	T	PB44A	5	BDQ42	T
AF13	PB35B	5	BDQ33	C	PB44B	5	BDQ42	C
VCCIO	VCCIO5	5			VCCIO5	5		
AE15	PB36A	5	BDQ33	T	PB45A	5	BDQ42	T
AG14	PB36B	5	BDQ33	C	PB45B	5	BDQ42	C
AH15	PB37A	5	BDQ33	T	PB46A	5	BDQ42	T
AK15	PB37B	5	BDQ33	C	PB46B	5	BDQ42	C
GNDIO	GNDIO5	-			GNDIO5	-		
AL15	PB38A	5	BDQ42	T	PB47A	5	BDQ51	T
AM15	PB38B	5	BDQ42	C	PB47B	5	BDQ51	C
AK16	PB39A	5	BDQ42	T	PB48A	5	BDQ51	T
AJ16	PB39B	5	BDQ42	C	PB48B	5	BDQ51	C
AN15	PB40A	5	BDQ42	T	PB49A	5	BDQ51	T
VCCIO	VCCIO5	5			VCCIO5	5		
AP15	PB40B	5	BDQ42	C	PB49B	5	BDQ51	C
AG15	PB42A	5	BDQS42	T	PB51A	5	BDQS51	T

LatticeECP2 Part Number Description



Ordering Information

Note: LatticeECP2 devices are dual marked. For example, the commercial speed grade LFE2-50E-7F672C is also marked with industrial grade -6I (LFE2-50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:



Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5F484I	304	1.2V	-5	fpBGA	484	IND	20
LFE2M20E-6F484I	304	1.2V	-6	fpBGA	484	IND	20
LFE2M20E-5F256I	140	1.2V	-5	fpBGA	256	IND	20
LFE2M20E-6F256I	140	1.2V	-6	fpBGA	256	IND	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5F672I	410	1.2V	-5	fpBGA	672	IND	35
LFE2M35E-6F672I	410	1.2V	-6	fpBGA	672	IND	35
LFE2M35E-5F484I	303	1.2V	-5	fpBGA	484	IND	35
LFE2M35E-6F484I	303	1.2V	-6	fpBGA	484	IND	35
LFE2M35E-5F256I	140	1.2V	-5	fpBGA	256	IND	35
LFE2M35E-6F256I	140	1.2V	-6	fpBGA	256	IND	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5F900I	410	1.2V	-5	fpBGA	900	IND	50
LFE2M50E-6F900I	410	1.2V	-6	fpBGA	900	IND	50
LFE2M50E-5F672I	372	1.2V	-5	fpBGA	672	IND	50
LFE2M50E-6F672I	372	1.2V	-6	fpBGA	672	IND	50
LFE2M50E-5F484I	270	1.2V	-5	fpBGA	484	IND	50
LFE2M50E-6F484I	270	1.2V	-6	fpBGA	484	IND	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5F1152I	436	1.2V	-5	fpBGA	1152	IND	70
LFE2M70E-6F1152I	436	1.2V	-6	fpBGA	1152	IND	70
LFE2M70E-5F900I	416	1.2V	-5	fpBGA	900	IND	70
LFE2M70E-6F900I	416	1.2V	-6	fpBGA	900	IND	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5F1152I	520	1.2V	-5	fpBGA	1152	IND	100
LFE2M100E-6F1152I	520	1.2V	-6	fpBGA	1152	IND	100
LFE2M100E-5F900I	416	1.2V	-5	fpBGA	900	IND	100
LFE2M100E-6F900I	416	1.2V	-6	fpBGA	900	IND	100